

100V N-Channel Enhancement Mode Power MOSFET

Description

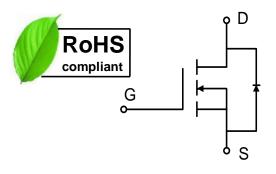
WMO73N10T2 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Features

- V_{DS} = 100 V, I_{D} = 73A $R_{DS(on)}$ < 8.5m Ω @ V_{GS} = 10 V $R_{DS(on)}$ < 11m Ω @ V_{GS} = 4.5V
- Green Device Available
- Low Gate Charge
- 100% EAS Guaranteed
- Low Rds(on)

Applications

- Power Management Switches
- Synchronous Rectification for AC/DC Quick Charger



TO-252

Absolute Maximum Ratings

Parameter		Symbol	Value	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _G s	±20	V	
Continuous Drain Current@10V1	T _C =25℃	l _D	73	Α	
	T _C =70°C	- ID	46		
Pulsed Drain Current ²		Ірм	290	Α	
Single Pulse Avalanche Energy ³		EAS	61	mJ	
Avalanche Current		las	35	Α	
Total Power Dissipation ⁴	T _C =25℃	P _D	108	W	
Operating Junction and Storage Temperature Range		ТЈ, Тѕтс	-55 to+150	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	Reja	55	°C/W
Thermal Resistance from Junction-to-Case ¹	R _θ JC	1.15	°C/W



Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static Characteristics				•			
Drain-Source Breakdown Vo	ltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$	100	-	-	V
Gate-body Leakage current		I _{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
Zero Gate Voltage Drain	T _J =25℃	I _{DSS}	V _{DS} = 80V, V _{GS} = 0V	-	-	1	μA
Current	TJ=55°C			-	-	5	-
Gate-Threshold Voltage		V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	1.2	1.7	2.3	V
Drain-Source On-Resistance ²		R _{DS(on)}	$V_{GS} = 10V, I_D = 13.5A$	-	5.8	8.5	mΩ
	Diain Oodide On-Nesistande		$V_{GS} = 4.5V, I_D = 11.5A$	-	7.5	11	
Forward Transconductance		G fs	$V_{DS} = 5V, I_{D} = 20A$	-	85	-	S
Dynamic Characteristics	3						
Input Capacitance		C _{iss}		-	2950	-	pF
Output Capacitance		C_{oss}	$V_{DS} = 50V, V_{GS} = 0V,$ f = 1MHz		430	-	
Reverse Transfer Capacitano	се	Crss]	-	12	-	-
Switching Characteristics							
Gate Resistance		R_g	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	-	0.6	-	Ω
Total Gate Charge		Qg	$V_{GS} = 4.5V, V_{DS} = 50V,$ $I_{D}=13.5A$	-	19.3	-	
Total Gate Charge		\mathbf{Q}_{g}		-	45	-	nC
Gate-Source Charge		\mathbf{Q}_{gs}	$V_{GS} = 10V, V_{DS} = 50V,$ $I_{D}=13.5A$	-	9.5	-	
Gate-Drain Charge		\mathbf{Q}_{gd}		-	4.8	-	1
Turn-On Delay Time		t _{d(on)}		-	10	-	
Rise Time Turn-Off Delay Time		t _r	$V_{GS} = 10V, V_{DD} = 50V,$ $R_{G} = 3\Omega, I_{D} = 13.5A$	-	6.5	-	nS
		t _{d(off)}		-	45	-	
Fall Time		tf	-	-	7.5	-	
Drain-Source Body Diode (Characteris	tics					
Diode Forward Voltage ²		V _{SD}	I _S = 1A, V _{GS} = 0V	-	-	1.1	V
Continuous Source Current ^{1,}	5	Is	VG=VD=0V,Force Current	-	-	48	Α
Reverse Recovery Time		Trr	1 40.54 4:44-4004	-	33	-	nS
Reverse Recovery Charge		Qrr	I _F = 13.5A, di/dt=100A/μs	-	150	-	nC

Notes:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3.The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =35A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



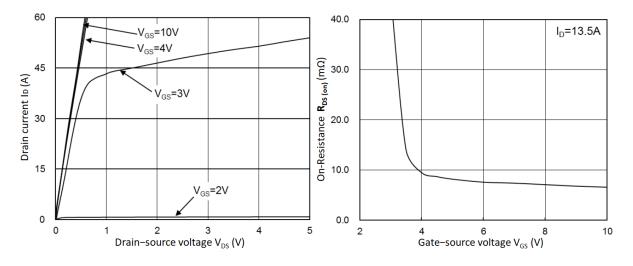
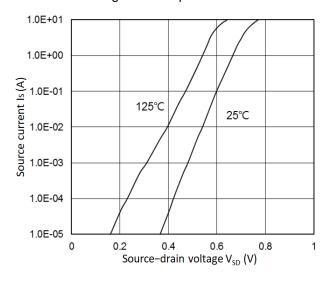


Figure 1. Output Characteristics

Figure 2. RDS(on) vs. VGS



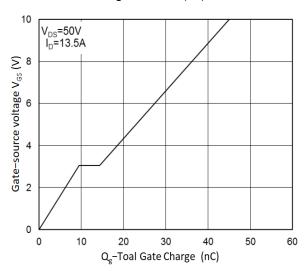
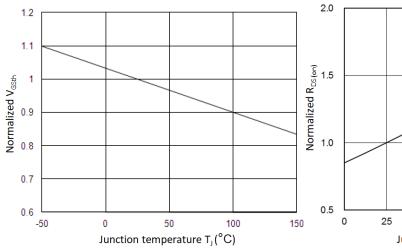


Figure 3. Forward Characteristics of Reverse

Figure 4. Gate Charge Characteristics



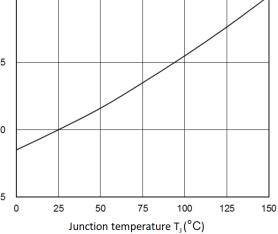
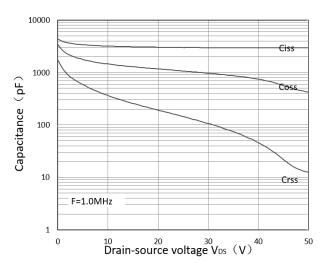


Figure 5. Normalized V_{GSth} vs. T_J

Figure 6. Normalized RDS(on) vs. TJ





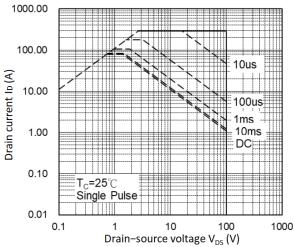


Figure 7. Capacitance Characteristics

Figure 8. Safe Operating Area

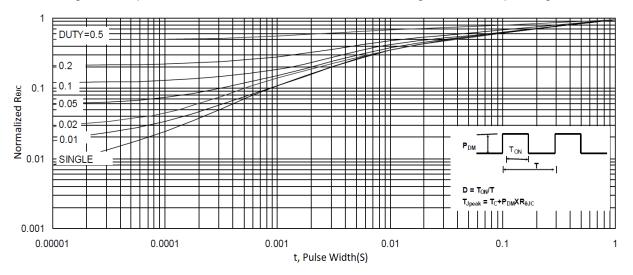
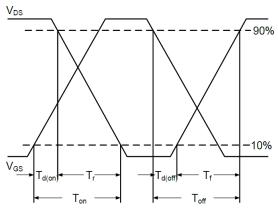
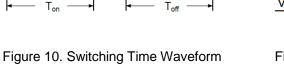


Figure 9. Normalized Maximum Transient Thermal Impedance





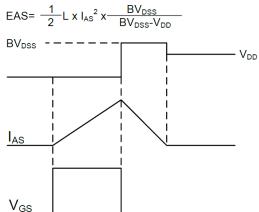
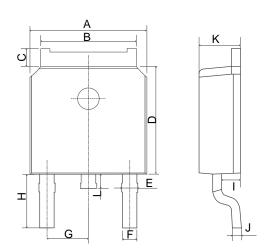


Figure 11. Unclamped Inductive Switching

Waveform



Mechanical Dimensions for TO-252



COMMON DIMENSIONS

	MM			
SYMBOL	MIN	MAX		
А	6.40	6.80		
В	5.13	5.50		
С	0.88	1.28		
D	5.90	6.22		
Е	0.68	1.10		
F	0.68	0.91		
G	2.29REF			
Н	2.90REF			
I	0.85	1.17		
J	0.51REF			
K	2.10	2.50		
L	0.40	1.00		



Ordering Information

Part	Package	Marking	Packing method
WMO73N10T2	TO-252	WMO73N10T2	Tape and Reel

Marking Information



WMO73N10T2 = Device code WWXX XXX= Date code

Contact Information

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